

# 74LVC125A

Quad buffer/line driver with 5 V tolerant input/outputs; 3-state

Rev. 7 — 11 April 2013

Product data sheet

## 1. General description

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The 74LVC125A consists of four non-inverting buffers/line drivers with 3-state outputs ( $\overline{nY}$ ) that are controlled by the output enable input ( $\overline{nOE}$ ). A HIGH at  $\overline{nOE}$  causes the outputs to assume a high-impedance OFF-state.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs.

## 2. Features and benefits

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- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Complies with JEDEC standard:
  - ◆ JESD8-7A (1.65 V to 1.95 V)
  - ◆ JESD8-5A (2.3 V to 2.7 V)
  - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ◆ MM JESD22-A115-B exceeds 200 V
  - ◆ CDM JESD22-C101E exceeds 1000 V
- Multiple package options
- Specified from  $-40\text{ }^{\circ}\text{C}$  to  $+85\text{ }^{\circ}\text{C}$  and  $-40\text{ }^{\circ}\text{C}$  to  $+125\text{ }^{\circ}\text{C}$

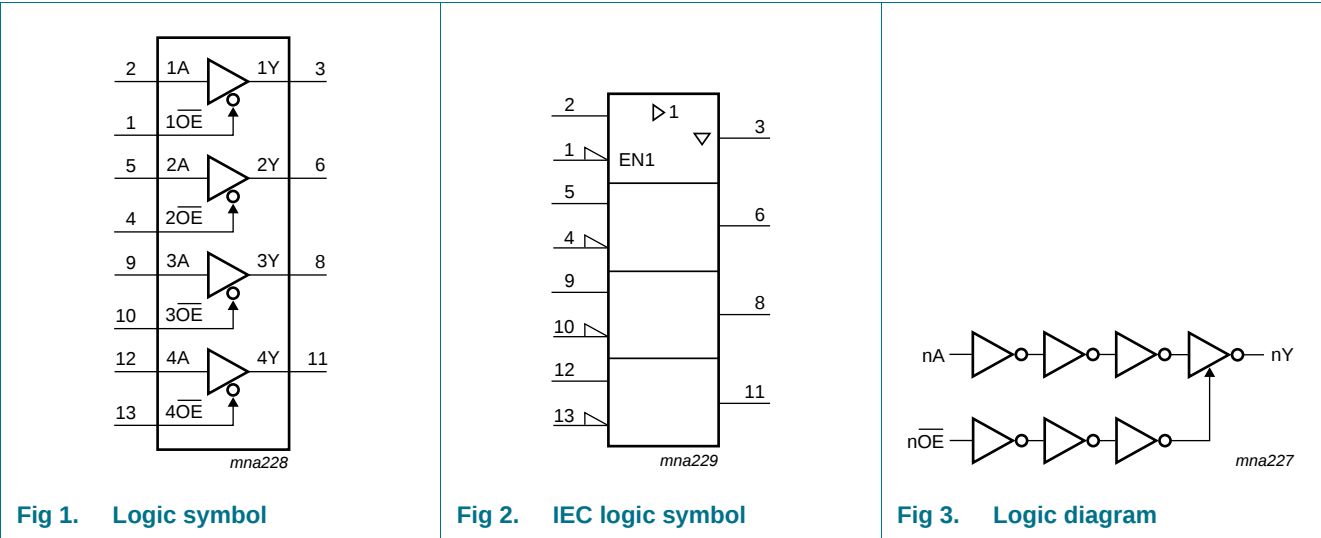


3. Ordering information

Table 1. Ordering information

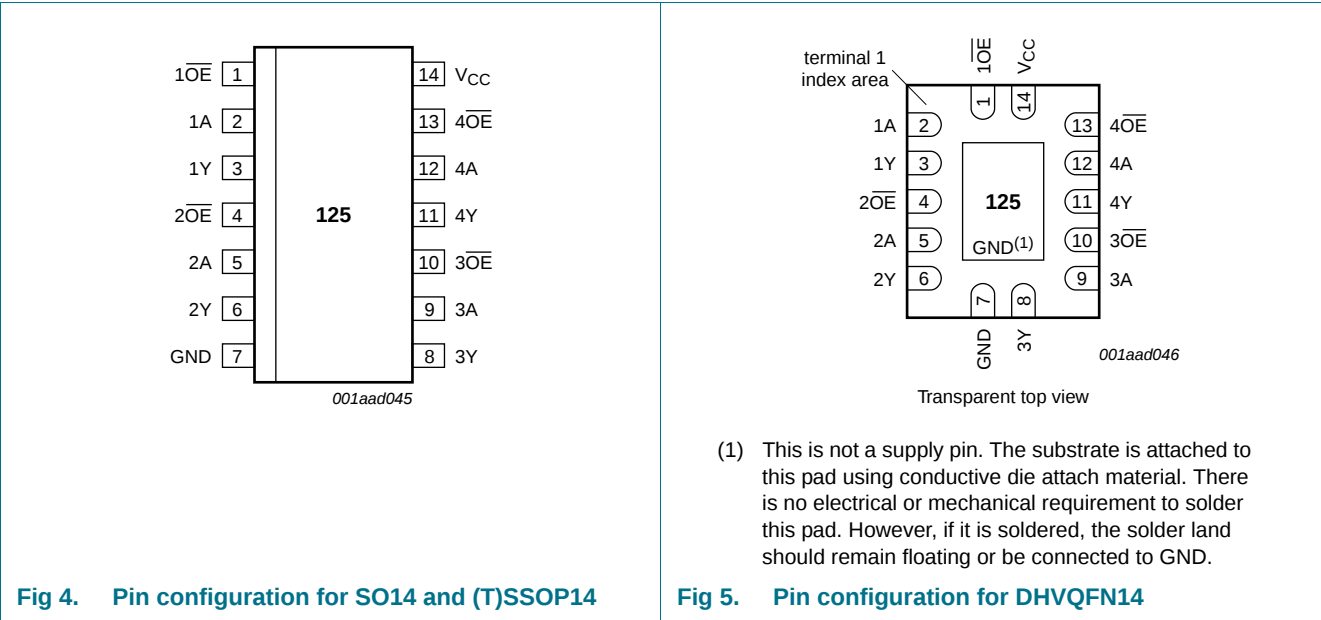
| Type number | Package           |          |                                                                                                                              | Version  |
|-------------|-------------------|----------|------------------------------------------------------------------------------------------------------------------------------|----------|
|             | Temperature range | Name     | Description                                                                                                                  |          |
| 74LVC125AD  | −40 °C to +125 °C | SO14     | plastic small outline package; 14 leads; body width 3.9 mm; body thickness 1.47 mm                                           | SOT108-1 |
| 74LVC125ADB | −40 °C to +125 °C | SSOP14   | plastic shrink small outline package; 14 leads; body width 5.3 mm                                                            | SOT337-1 |
| 74LVC125APW | −40 °C to +125 °C | TSSOP14  | plastic thin shrink small outline package; 14 leads; body width 4.4 mm                                                       | SOT402-1 |
| 74LVC125ABQ | −40 °C to +125 °C | DHVQFN14 | plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm | SOT762-1 |

4. Functional diagram



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

| Symbol             | Pin          | Description                    |
|--------------------|--------------|--------------------------------|
| 1OE, 2OE, 3OE, 4OE | 1, 4, 10, 13 | data enable input (active LOW) |
| 1A, 2A, 3A, 4A     | 2, 5, 9, 12  | data input                     |
| 1Y, 2Y, 3Y, 4Y     | 3, 6, 8, 11  | data output                    |
| GND                | 7            | ground (0 V)                   |
| VCC                | 14           | supply voltage                 |

6. Functional description

Table 3. Function selection<sup>[1]</sup>

| Inputs |    | Output |
|--------|----|--------|
| nOE    | nA | nY     |
| L      | L  | L      |
| L      | H  | H      |
| H      | X  | Z      |

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state

## 7. Limiting values

**Table 4. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol    | Parameter               | Conditions                    | Min      | Max            | Unit |
|-----------|-------------------------|-------------------------------|----------|----------------|------|
| $V_{CC}$  | supply voltage          |                               | -0.5     | +6.5           | V    |
| $I_{IK}$  | input clamping current  | $V_I < 0$ V                   | -50      | -              | mA   |
| $V_I$     | input voltage           |                               | [1] -0.5 | +6.5           | V    |
| $I_{OK}$  | output clamping current | $V_O > V_{CC}$ or $V_O < 0$ V | -        | $\pm 50$       | mA   |
| $V_O$     | output voltage          | output HIGH or LOW-state      | [2] -0.5 | $V_{CC} + 0.5$ | V    |
|           |                         | output 3-state                | [2] -0.5 | +6.5           | V    |
| $I_O$     | output current          | $V_O = 0$ V to $V_{CC}$       | -        | $\pm 50$       | mA   |
| $I_{CC}$  | supply current          |                               | -        | 100            | mA   |
| $I_{GND}$ | ground current          |                               | -100     | -              | mA   |
| $P_{tot}$ | total power dissipation | $T_{amb} = -40$ °C to +125 °C | [3] -    | 500            | mW   |
| $T_{stg}$ | storage temperature     |                               | -65      | +150           | °C   |

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO14 packages: above 70 °C derate linearly with 8 mW/K.

For (T)SSOP14 packages: above 60 °C derate linearly with 5.5 mW/K.

For DHVQFN14 packages: above 60 °C derate linearly with 4.5 mW/K.

## 8. Recommended operating conditions

**Table 5. Recommended operating conditions**

| Symbol              | Parameter                           | Conditions                | Min  | Typ | Max      | Unit |
|---------------------|-------------------------------------|---------------------------|------|-----|----------|------|
| $V_{CC}$            | supply voltage                      |                           | 1.65 | -   | 3.6      | V    |
|                     |                                     | functional                | 1.2  | -   | -        | V    |
| $V_I$               | input voltage                       |                           | 0    | -   | 5.5      | V    |
| $V_O$               | output voltage                      | output HIGH or LOW state  | 0    | -   | $V_{CC}$ | V    |
|                     |                                     | output 3-state            | 0    | -   | 5.5      | V    |
| $T_{amb}$           | ambient temperature                 |                           | -40  | -   | +125     | °C   |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 2.3$ V to 2.7 V | 0    | -   | 20       | ns/V |
|                     |                                     | $V_{CC} = 2.7$ V to 3.6 V | 0    | -   | 10       | ns/V |

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

| Symbol           | Parameter                 | Conditions                                                                                                      | –40 °C to +85 °C       |                    |                        | –40 °C to +125 °C      |                        | Unit |
|------------------|---------------------------|-----------------------------------------------------------------------------------------------------------------|------------------------|--------------------|------------------------|------------------------|------------------------|------|
|                  |                           |                                                                                                                 | Min                    | Typ <sup>[1]</sup> | Max                    | Min                    | Max                    |      |
| V <sub>IH</sub>  | HIGH-level input voltage  | V <sub>CC</sub> = 1.2 V                                                                                         | 1.08                   | -                  | -                      | 1.08                   | -                      | V    |
|                  |                           | V <sub>CC</sub> = 1.65 V to 1.95 V                                                                              | 0.65 × V <sub>CC</sub> | -                  | -                      | 0.65 × V <sub>CC</sub> | -                      | V    |
|                  |                           | V <sub>CC</sub> = 2.3 V to 2.7 V                                                                                | 1.7                    | -                  | -                      | 1.7                    | -                      | V    |
|                  |                           | V <sub>CC</sub> = 2.7 V to 3.6 V                                                                                | 2.0                    | -                  | -                      | 2.0                    | -                      | V    |
| V <sub>IL</sub>  | LOW-level input voltage   | V <sub>CC</sub> = 1.2 V                                                                                         | -                      | -                  | 0.12                   | -                      | 0.12                   | V    |
|                  |                           | V <sub>CC</sub> = 1.65 V to 1.95 V                                                                              | -                      | -                  | 0.35 × V <sub>CC</sub> | -                      | 0.35 × V <sub>CC</sub> | V    |
|                  |                           | V <sub>CC</sub> = 2.3 V to 2.7 V                                                                                | -                      | -                  | 0.7                    | -                      | 0.7                    | V    |
|                  |                           | V <sub>CC</sub> = 2.7 V to 3.6 V                                                                                | -                      | -                  | 0.8                    | -                      | 0.8                    | V    |
| V <sub>OH</sub>  | HIGH-level output voltage | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                                             |                        |                    |                        |                        |                        |      |
|                  |                           | I <sub>O</sub> = –100 µA; V <sub>CC</sub> = 1.65 V to 3.6 V                                                     | V <sub>CC</sub> – 0.2  | -                  | -                      | V <sub>CC</sub> – 0.3  | -                      | V    |
|                  |                           | I <sub>O</sub> = –4 mA; V <sub>CC</sub> = 1.65 V                                                                | 1.2                    | -                  | -                      | 1.05                   | -                      | V    |
|                  |                           | I <sub>O</sub> = –8 mA; V <sub>CC</sub> = 2.3 V                                                                 | 1.8                    | -                  | -                      | 1.65                   | -                      | V    |
|                  |                           | I <sub>O</sub> = –12 mA; V <sub>CC</sub> = 2.7 V                                                                | 2.2                    | -                  | -                      | 2.05                   | -                      | V    |
|                  |                           | I <sub>O</sub> = –18 mA; V <sub>CC</sub> = 3.0 V                                                                | 2.4                    | -                  | -                      | 2.25                   | -                      | V    |
|                  |                           | I <sub>O</sub> = –24 mA; V <sub>CC</sub> = 3.0 V                                                                | 2.2                    | -                  | -                      | 2.0                    | -                      | V    |
| V <sub>OL</sub>  | LOW-level output voltage  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>                                                             |                        |                    |                        |                        |                        |      |
|                  |                           | I <sub>O</sub> = 100 µA; V <sub>CC</sub> = 1.65 V to 3.6 V                                                      | -                      | -                  | 0.2                    | -                      | 0.3                    | V    |
|                  |                           | I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V                                                                 | -                      | -                  | 0.45                   | -                      | 0.65                   | V    |
|                  |                           | I <sub>O</sub> = 8 mA; V <sub>CC</sub> = 2.3 V                                                                  | -                      | -                  | 0.6                    | -                      | 0.8                    | V    |
|                  |                           | I <sub>O</sub> = 12 mA; V <sub>CC</sub> = 2.7 V                                                                 | -                      | -                  | 0.4                    | -                      | 0.6                    | V    |
|                  |                           | I <sub>O</sub> = 24 mA; V <sub>CC</sub> = 3.0 V                                                                 | -                      | -                  | 0.55                   | -                      | 0.8                    | V    |
| I <sub>I</sub>   | input leakage current     | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 5.5 V or GND                                                          | -                      | ±0.1               | ±5                     | -                      | ±20                    | µA   |
| I <sub>OZ</sub>  | OFF-state output current  | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> ; V <sub>CC</sub> = 3.6 V; V <sub>O</sub> = 5.5 V or GND    | -                      | ±0.1               | ±5                     | -                      | ±20                    | µA   |
| I <sub>OFF</sub> | power-off leakage current | V <sub>CC</sub> = 0.0 V; V <sub>I</sub> or V <sub>O</sub> = 5.5 V                                               | -                      | ±0.1               | ±10                    | -                      | ±20                    | µA   |
| I <sub>CC</sub>  | supply current            | V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub> or GND; I <sub>O</sub> = 0 A                          | -                      | 0.1                | 10                     | -                      | 40                     | µA   |
| ΔI <sub>CC</sub> | additional supply current | per input pin; V <sub>I</sub> = V <sub>CC</sub> – 0.6 V; I <sub>O</sub> = 0 A; V <sub>CC</sub> = 2.7 V to 3.6 V | -                      | 5                  | 500                    | -                      | 5000                   | µA   |
| C <sub>I</sub>   | input capacitance         | V <sub>CC</sub> = 0 V to 3.6 V; V <sub>I</sub> = GND to V <sub>CC</sub>                                         | -                      | 4.0                | -                      | -                      | -                      | pF   |

[1] All typical values are measured at V<sub>CC</sub> = 3.3 V (unless stated otherwise) and T<sub>amb</sub> = 25 °C.

## 10. Dynamic characteristics

**Table 7. Dynamic characteristics**

Voltages are referenced to GND (ground = 0 V). For test circuit see [Figure 8](#).

| Symbol      | Parameter                     | Conditions                                                          | –40 °C to +85 °C |                    |      | –40 °C to +125 °C |      | Unit |
|-------------|-------------------------------|---------------------------------------------------------------------|------------------|--------------------|------|-------------------|------|------|
|             |                               |                                                                     | Min              | Typ <sup>[1]</sup> | Max  | Min               | Max  |      |
| $t_{pd}$    | propagation delay             | nA to nY; see <a href="#">Figure 6</a> <sup>[2]</sup>               |                  |                    |      |                   |      |      |
|             |                               | $V_{CC} = 1.2\text{ V}$                                             | -                | 12.0               | -    | -                 | -    | ns   |
|             |                               | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$                           | 1.5              | 5.4                | 11.0 | 1.5               | 12.8 | ns   |
|             |                               | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$                             | 1.0              | 2.9                | 5.7  | 1.0               | 6.7  | ns   |
|             |                               | $V_{CC} = 2.7\text{ V}$                                             | 1.5              | 2.8                | 5.5  | 1.5               | 7.0  | ns   |
| $t_{en}$    | enable time                   | $\overline{nOE}$ to nY; see <a href="#">Figure 7</a> <sup>[2]</sup> |                  |                    |      |                   |      |      |
|             |                               | $V_{CC} = 1.2\text{ V}$                                             | -                | 16.0               | -    | -                 | -    | ns   |
|             |                               | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$                           | 1.0              | 5.0                | 12.2 | 1.0               | 14.2 | ns   |
|             |                               | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$                             | 0.5              | 2.9                | 6.8  | 0.5               | 7.9  | ns   |
|             |                               | $V_{CC} = 2.7\text{ V}$                                             | 1.5              | 3.1                | 6.6  | 1.5               | 8.5  | ns   |
| $t_{dis}$   | disable time                  | $\overline{nOE}$ to nY; see <a href="#">Figure 7</a> <sup>[2]</sup> |                  |                    |      |                   |      |      |
|             |                               | $V_{CC} = 1.2\text{ V}$                                             | -                | 7.0                | -    | -                 | -    | ns   |
|             |                               | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$                           | 2.2              | 4.6                | 7.5  | 2.2               | 8.7  | ns   |
|             |                               | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$                             | 0.5              | 2.6                | 4.2  | 0.5               | 5.0  | ns   |
|             |                               | $V_{CC} = 2.7\text{ V}$                                             | 1.5              | 3.1                | 5.0  | 1.5               | 6.5  | ns   |
| $t_{sk(o)}$ | output skew time              | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ <sup>[3]</sup>              | -                | -                  | 1.0  | -                 | 1.5  | ns   |
|             |                               | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$                           | -                | 6.0                | -    | -                 | -    | pF   |
|             |                               | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$                             | -                | 9.4                | -    | -                 | -    | pF   |
|             |                               | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$                             | -                | 12.4               | -    | -                 | -    | pF   |
|             |                               | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$                           | -                | 6.0                | -    | -                 | -    | pF   |
| $C_{PD}$    | power dissipation capacitance | per buffer; $V_I = \text{GND to }V_{CC}$ <sup>[4]</sup>             |                  |                    |      |                   |      |      |
|             |                               | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$                           | -                | 6.0                | -    | -                 | -    | pF   |
|             |                               | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$                             | -                | 9.4                | -    | -                 | -    | pF   |
|             |                               | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$                             | -                | 12.4               | -    | -                 | -    | pF   |

[1] Typical values are measured at  $T_{amb} = 25\text{ °C}$  and  $V_{CC} = 1.2\text{ V}, 1.8\text{ V}, 2.5\text{ V}, 2.7\text{ V}$ , and  $3.3\text{ V}$  respectively.

[2]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

$t_{en}$  is the same as  $t_{PZL}$  and  $t_{PZH}$ .

$t_{dis}$  is the same as  $t_{PLZ}$  and  $t_{PHZ}$ .

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu\text{W}$ ).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$  where:

$f_i$  = input frequency in MHz;  $f_o$  = output frequency in MHz

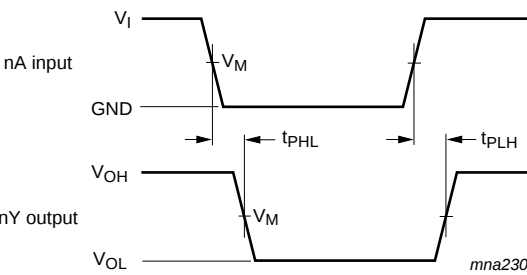
$C_L$  = output load capacitance in pF

$V_{CC}$  = supply voltage in Volts

$N$  = number of inputs switching

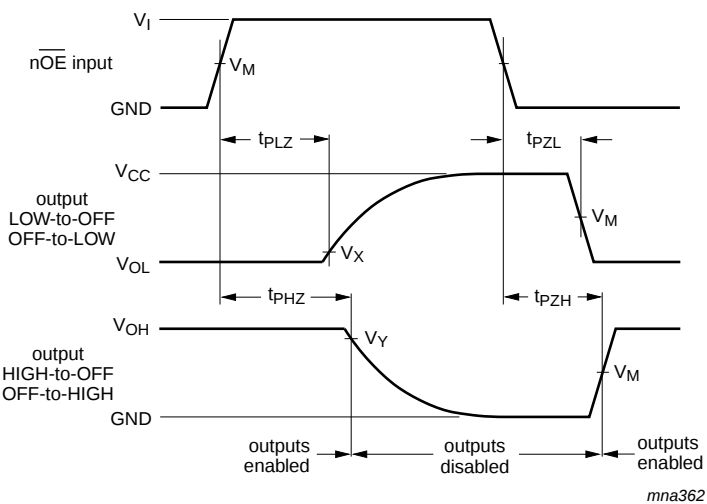
$\Sigma(C_L \times V_{CC}^2 \times f_o)$  = sum of the outputs.

11. AC waveforms



Measurement points are given in [Table 8](#).  
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 6. The input nA to output nY propagation delays**

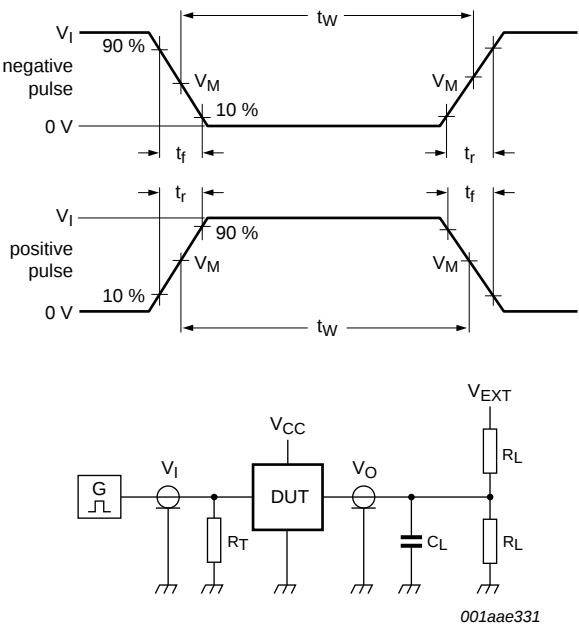


Measurement points are given in [Table 8](#).  
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

**Fig 7. 3-state enable and disable times**

**Table 8. Measurement points**

| Supply voltage   | Input    |                     | Output              |
|------------------|----------|---------------------|---------------------|
| $V_{CC}$         | $V_I$    | $V_M$               | $V_M$               |
| 1.2 V            | $V_{CC}$ | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 1.65 V to 1.95 V | $V_{CC}$ | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 2.3 V to 2.7 V   | $V_{CC}$ | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ |
| 2.7 V            | 2.7 V    | 1.5 V               | 1.5 V               |
| 3.0 V to 3.6 V   | 2.7 V    | 1.5 V               | 1.5 V               |



Test data is given in [Table 9](#).  
Definitions for test circuit:  
 $R_L$  = Load resistance.  
 $C_L$  = Load capacitance including jig and probe capacitance.  
 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator.  
 $V_{EXT}$  = External voltage for measuring switching times.

Fig 8. Test circuit for measuring switching times

Table 9. Test data

| Supply voltage   | Input           |                                 | Load           |                | V <sub>EXT</sub>                    |                                     |                                     |
|------------------|-----------------|---------------------------------|----------------|----------------|-------------------------------------|-------------------------------------|-------------------------------------|
|                  | V <sub>I</sub>  | t <sub>r</sub> , t <sub>f</sub> | C <sub>L</sub> | R <sub>L</sub> | t <sub>PLH</sub> , t <sub>PHL</sub> | t <sub>PLZ</sub> , t <sub>PZL</sub> | t <sub>PHZ</sub> , t <sub>PZH</sub> |
| 1.2 V            | V <sub>CC</sub> | ≤ 2 ns                          | 30 pF          | 1 kΩ           | open                                | 2 × V <sub>CC</sub>                 | GND                                 |
| 1.65 V to 1.95 V | V <sub>CC</sub> | ≤ 2 ns                          | 30 pF          | 1 kΩ           | open                                | 2 × V <sub>CC</sub>                 | GND                                 |
| 2.3 V to 2.7 V   | V <sub>CC</sub> | ≤ 2 ns                          | 30 pF          | 500 Ω          | open                                | 2 × V <sub>CC</sub>                 | GND                                 |
| 2.7 V            | 2.7 V           | ≤ 2.5 ns                        | 50 pF          | 500 Ω          | open                                | 2 × V <sub>CC</sub>                 | GND                                 |
| 3.0 V to 3.6 V   | 2.7 V           | ≤ 2.5 ns                        | 50 pF          | 500 Ω          | open                                | 2 × V <sub>CC</sub>                 | GND                                 |

12. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

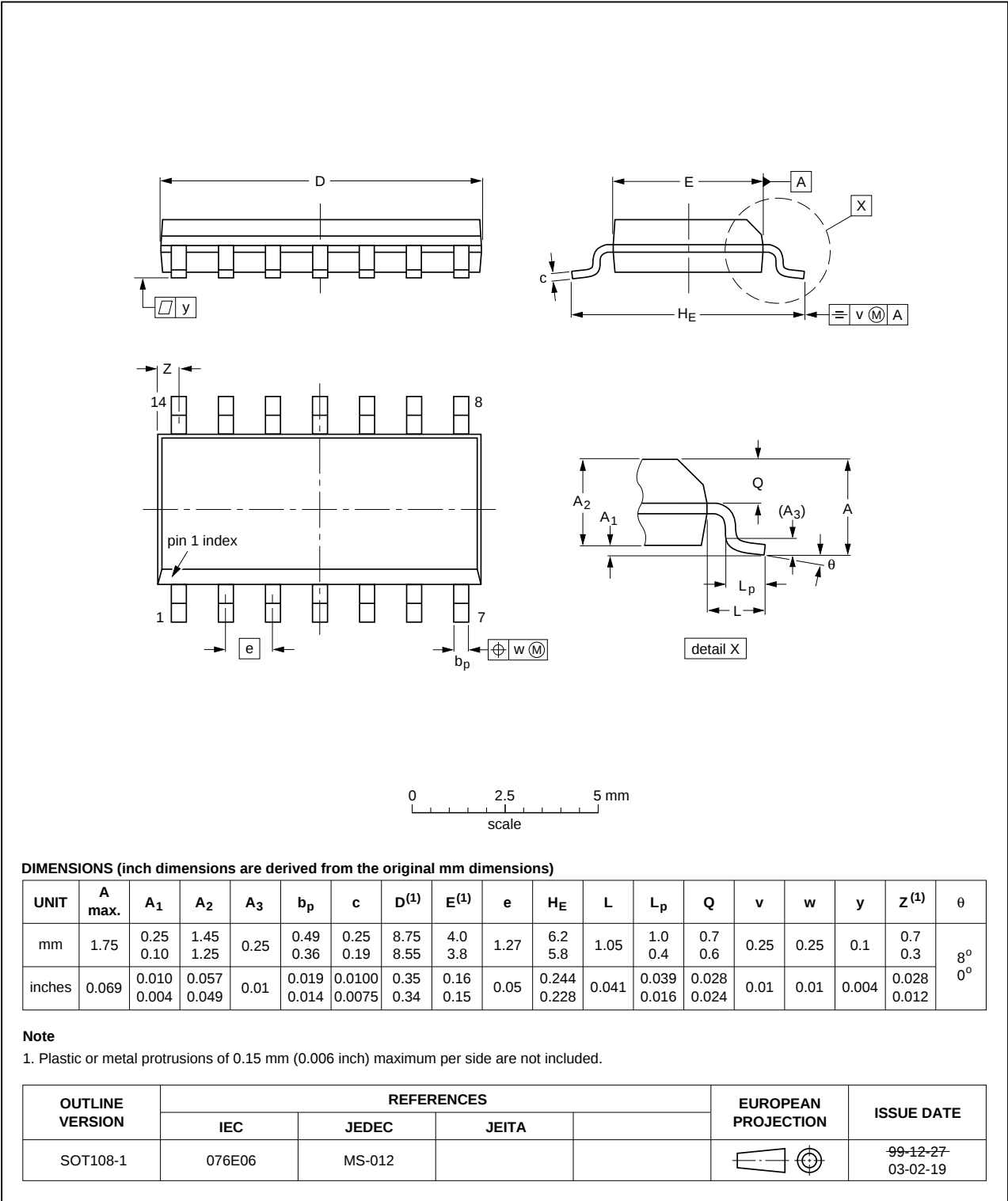


Fig 9. Package outline SOT108-1 (SO14)

SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

SOT337-1

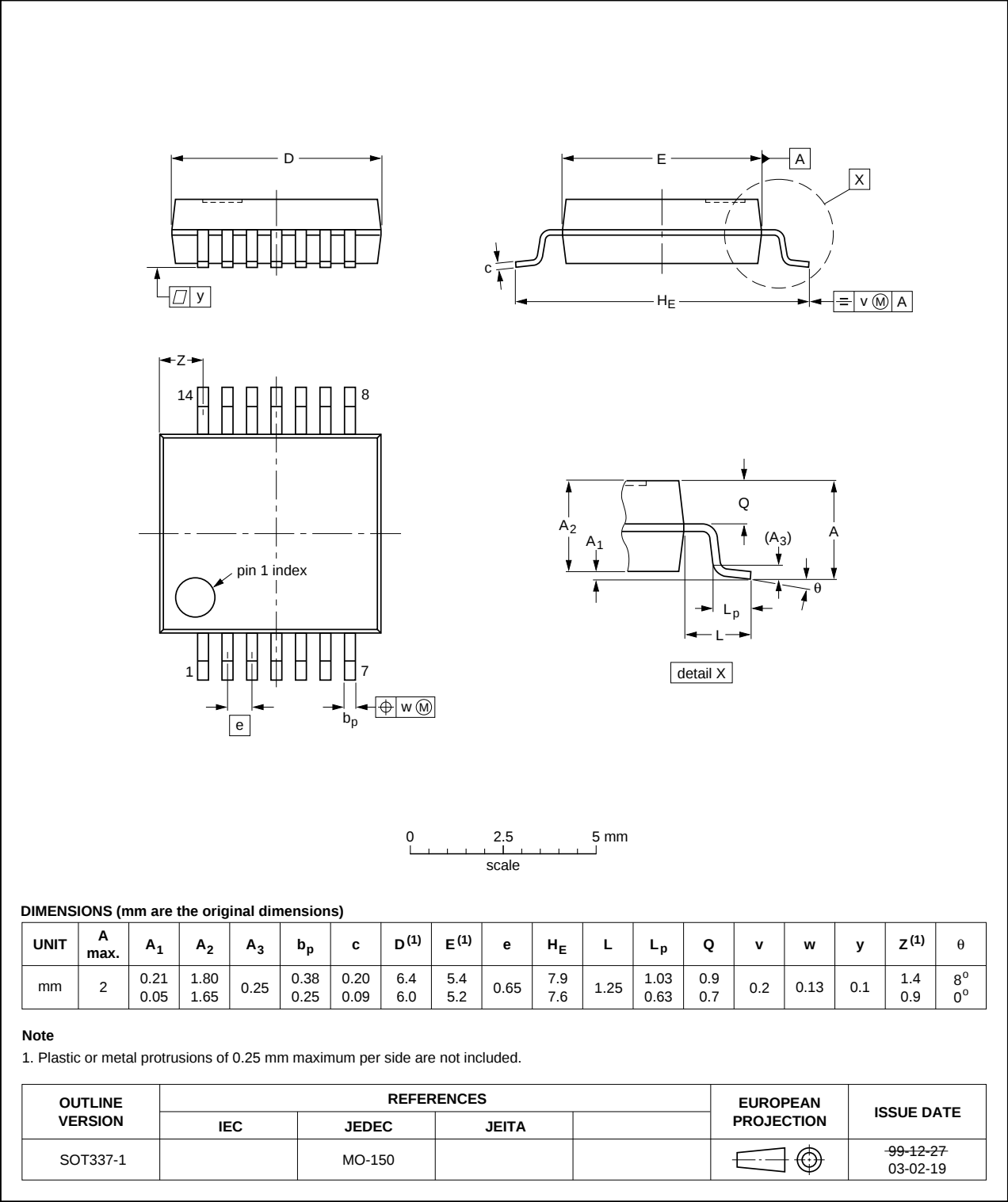


Fig 10. Package outline SOT337-1 (SSOP14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

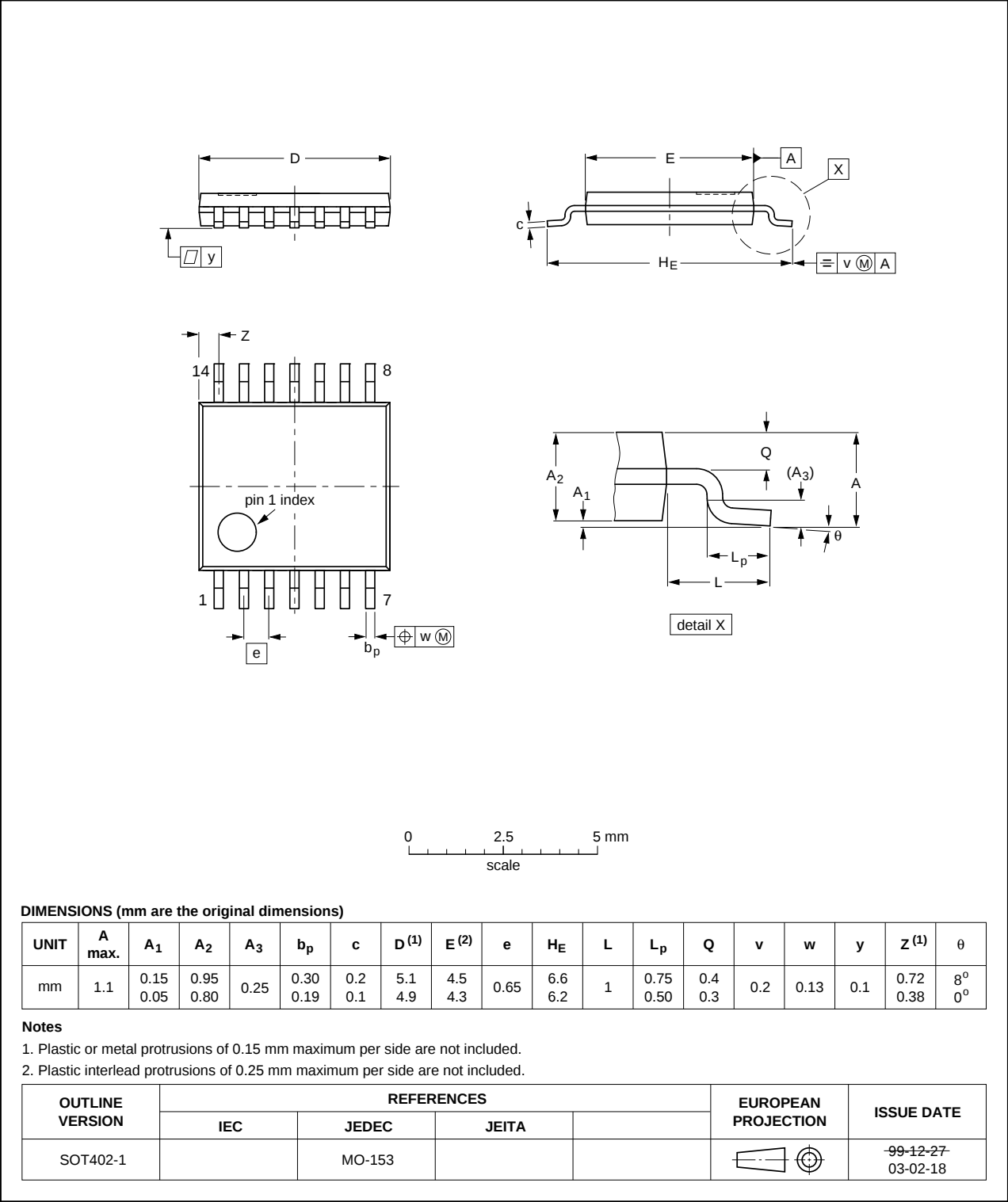


Fig 11. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

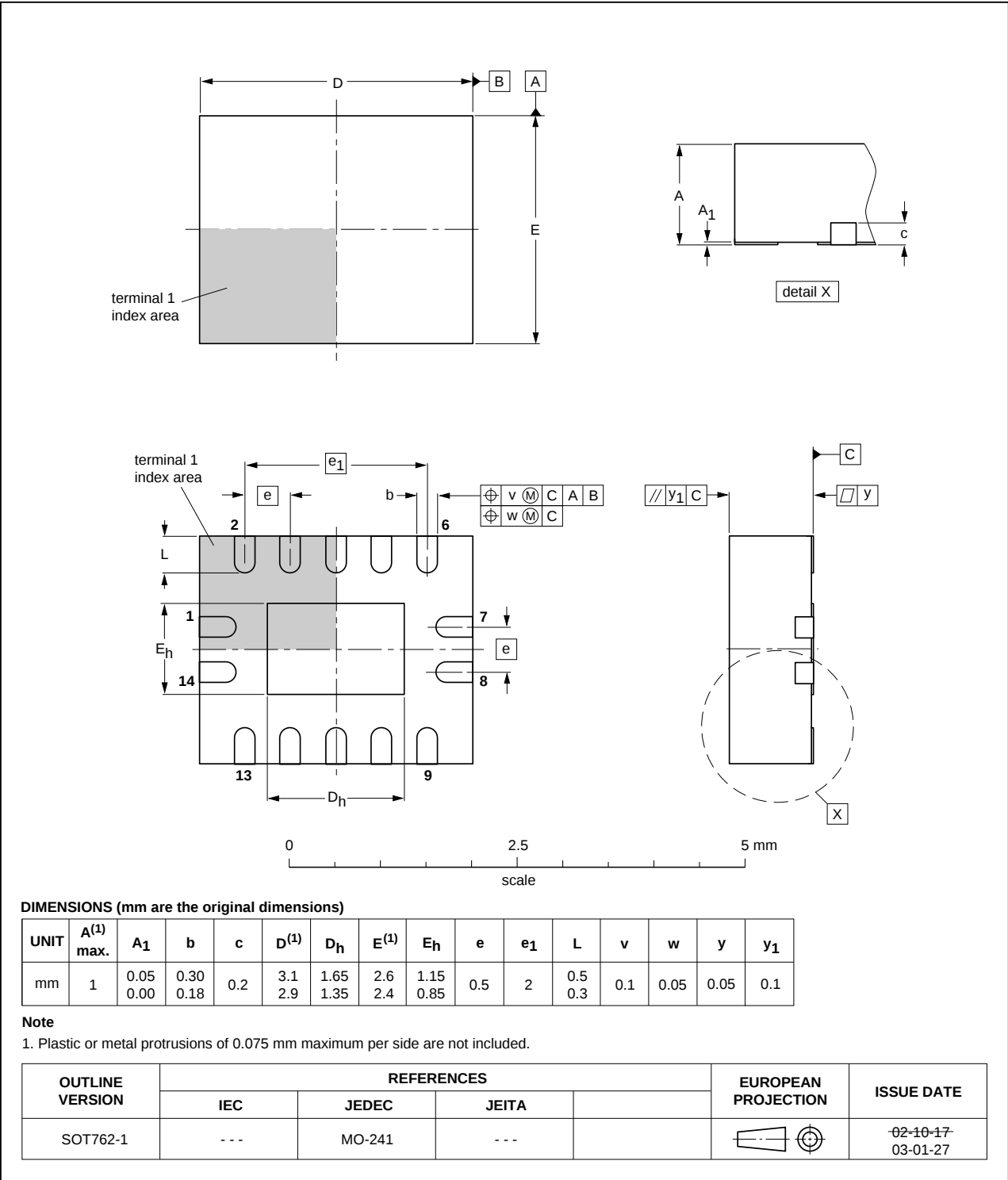


Fig 12. Package outline SOT762-1 (DHVQFN14)

## 13. Abbreviations

Table 10. Abbreviations

| Acronym | Description                 |
|---------|-----------------------------|
| CDM     | Charged Device Model        |
| DUT     | Device Under Test           |
| ESD     | ElectroStatic Discharge     |
| MM      | Machine Model               |
| HBM     | Human Body Model            |
| TTL     | Transistor-Transistor Logic |

## 14. Revision history

Table 11. Revision history

| Document ID    | Release date                       | Data sheet status     | Change notice | Supersedes    |
|----------------|------------------------------------|-----------------------|---------------|---------------|
| 74LVC125A v.7  | 20130411                           | Product data sheet    | -             | 74LVC125A v.6 |
| Modifications: | • Features list corrected (errata) |                       |               |               |
| 74LVC125A v.6  | 20130305                           | Product data sheet    | -             | 74LVC125A v.5 |
| 74LVC125A v.5  | 20120208                           | Product data sheet    | -             | 74LVC125A v.4 |
| 74LVC125A v.4  | 20030507                           | Product specification | -             | 74LVC125A v.3 |
| 74LVC125A v.3  | 20020308                           | Product specification | -             | 74LVC125A v.2 |
| 74LVC125A v.2  | 19980428                           | Product specification | -             | 74LVC125A v.1 |
| 74LVC125A v.1  | 19970801                           | Product specification | -             | -             |

## 15. Legal information

### 15.1 Data sheet status

| Document status <sup>[1][2]</sup> | Product status <sup>[3]</sup> | Definition                                                                            |
|-----------------------------------|-------------------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet      | Development                   | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet    | Qualification                 | This document contains data from the preliminary specification.                       |
| Product [short] data sheet        | Production                    | This document contains the product specification.                                     |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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